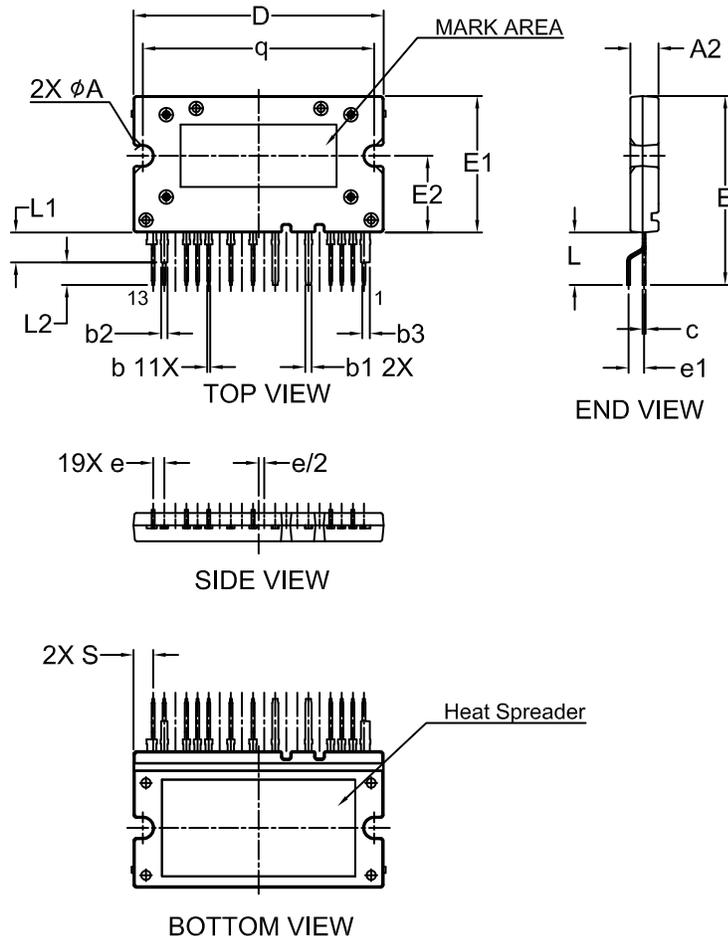
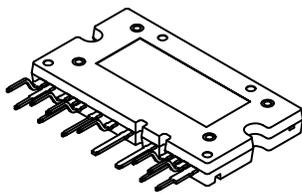


**ASPMCA-A16 / 13LD, AUTOMOTIVE MODULE  
CASE MODGH  
ISSUE B**

DATE 03 NOV 2020

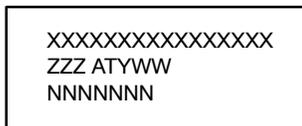


NOTES:

1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A2	4.30	4.50	4.70
b	0.45	0.50	0.60
b1	0.95	1.00	1.10
b2	0.95	1.00	1.10
b3	1.15	1.20	1.30
c	0.45	0.50	0.60
D	39.90	40.10	40.30
E	29.80	30.30	30.80
E1	21.70	21.90	22.10
E2	12.10	12.30	12.50
e	1.478	1.778	2.078
e1	2.20	2.50	2.80
L	8.10	8.40	8.70
L1	4.80 REF		
L2	3.30	3.60	3.90
q	36.85	37.10	37.35
S	3.159 REF		
φA	2.95	3.20	3.45

**GENERIC  
MARKING DIAGRAM\***



XXXX = Specific Device Code  
 ZZZ = Lot ID  
 AT = Assembly & Test Location  
 Y = Year  
 W = Work Week  
 NNN = Serial Number

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "μ", may or may not be present. Some products may not follow the Generic Marking.

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<b>DESCRIPTION:</b>	<b>ASPMCA-A16 / 13LD, AUTOMOTIVE MODULE</b>	<b>PAGE 1 OF 1</b>

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